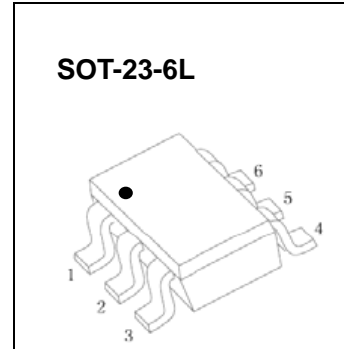




**SOT-23-6L Plastic-Encapsulate MOSFETS**

**CJL8810 Dual N-Channel MOSFET**

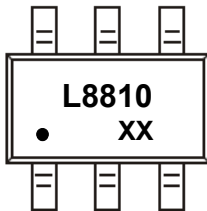
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
20V	14.5mΩ@4.5V	7A
	15.6mΩ@3.8V	
	18.5mΩ@2.5V	
	28mΩ@1.8V	



**DESCRIPTION**

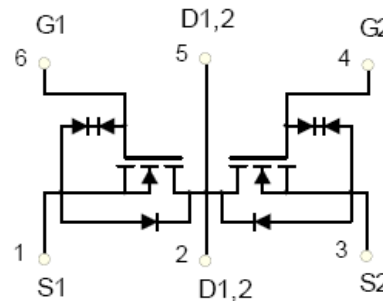
The CJL8810 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. It is ESD protected. This device is suitable for use as a uni-directional or bi-directional load switch, facilitated by its common-drain configuration.

**MARKING:**



L8810=Device code  
 Solid point=Pin1 positioning point  
 XX=Date Code

**Equivalent Circuit**



**MAXIMUM RATINGS ( $T_a=25^{\circ}C$  unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	±12	V
Continuous Drain Current	$I_D$	7	A
Pulsed Drain Current	$I_{DM}^*$	30	A
Power Dissipation	$P_D$ ③	714	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$ ③	175	°C/W
Operation Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	$T_L$	260	°C

\*Repetitive rating: Pulse width limited by junction temperature.

# MOSFET ELECTRICAL CHARACTERISTICS

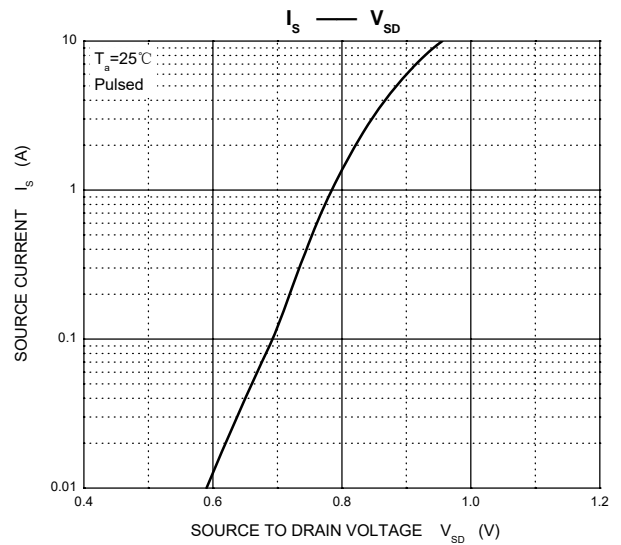
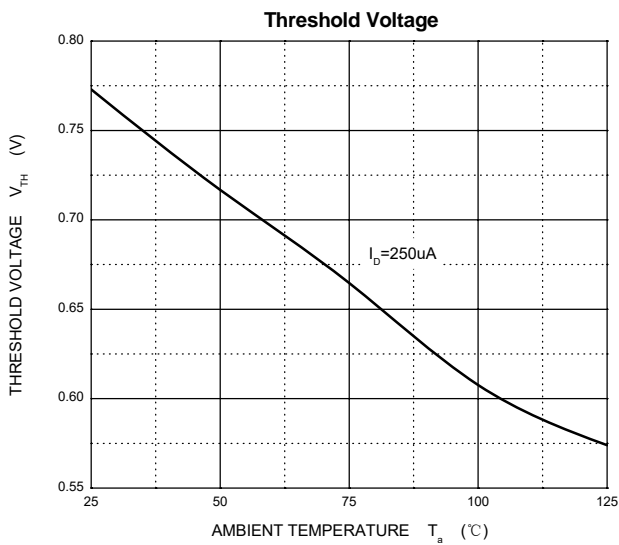
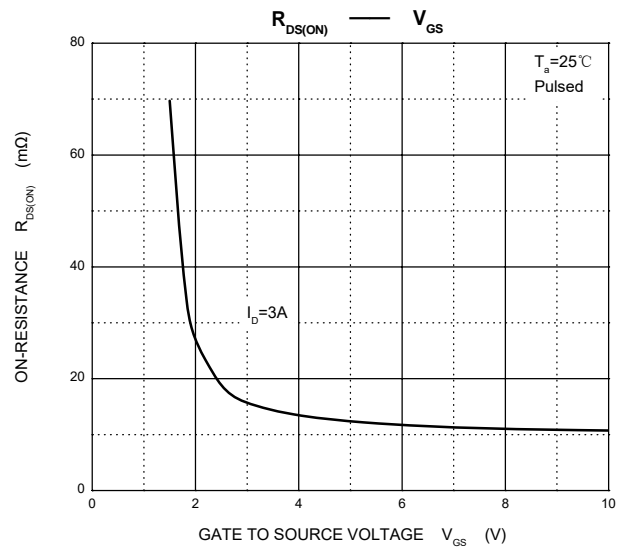
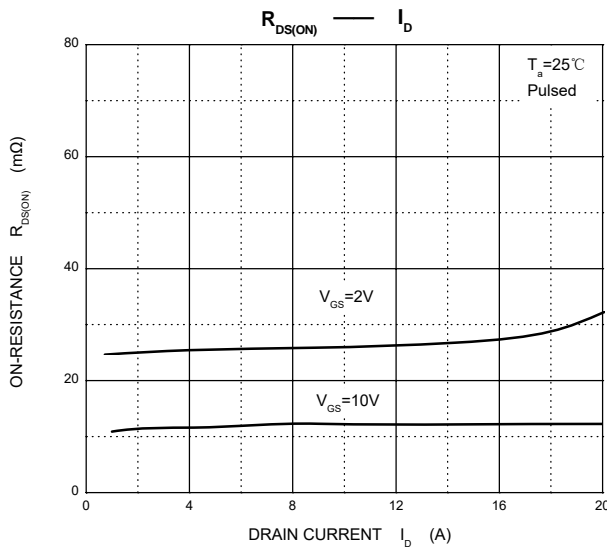
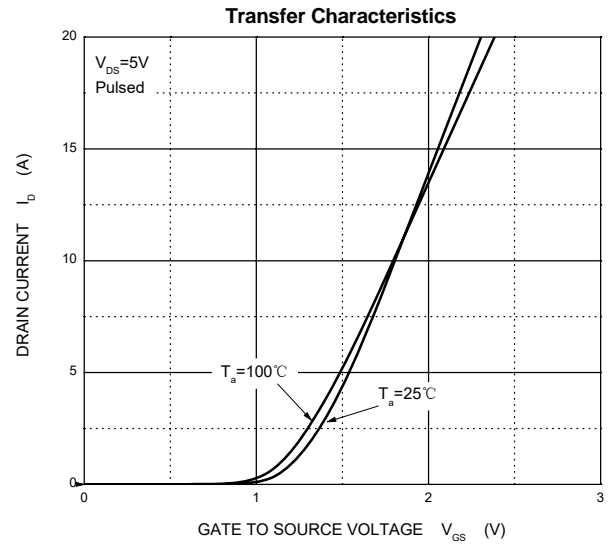
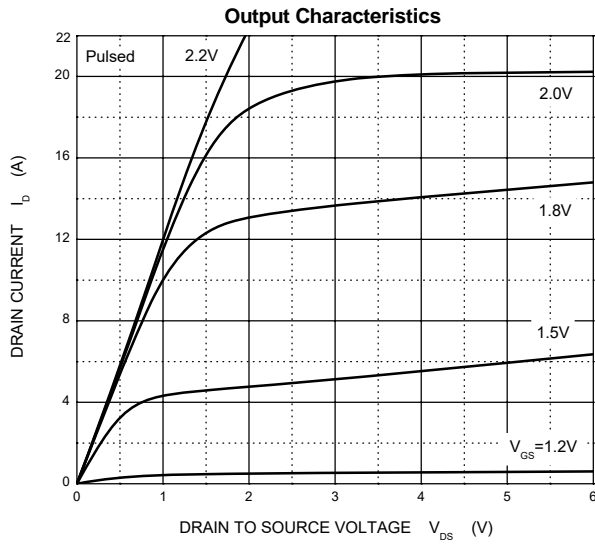
$T_a=25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 16V, V_{GS} = 0V$			1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 4.5V, V_{DS} = 0V$			$\pm 1$	$\mu A$
		$V_{GS} = \pm 10V, V_{DS} = 0V$			$\pm 5$	$\mu A$
Gate threshold voltage <sup>①</sup>	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.4		1	V
Drain-source on-resistance <sup>①</sup>	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 3A$	10.5	13.5	20	m $\Omega$
		$V_{GS} = 4.5V, I_D = 3A$	11.5	14.5	22	m $\Omega$
		$V_{GS} = 3.8V, I_D = 3A$	12.6	15.6	24	m $\Omega$
		$V_{GS} = 2.5V, I_D = 3A$	14.5	18.5	26	m $\Omega$
		$V_{GS} = 1.8V, I_D = 3A$	20.5	28	35	m $\Omega$
Forward transconductance <sup>①</sup>	$g_{FS}$	$V_{DS} = 5V, I_D = 7A$	9			S
Diode forward voltage <sup>①</sup>	$V_{SD}$	$I_S = 1A, V_{GS} = 0V$			1	V
<b>DYNAMIC PARAMETERS<sup>②</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 10V, V_{GS} = 0V, f = 1MHz$		1150		pF
Output Capacitance	$C_{oss}$			185		pF
Reverse Transfer Capacitance	$C_{rss}$			145		pF
Total gate charge	$Q_g$	$V_{DS} = 10V, V_{GS} = 4.5V, I_D = 7A$		15		nC
Gate-source charge	$Q_{gs}$			0.8		nC
Gate-drain charge	$Q_{gd}$			3.2		nC
<b>SWITCHING PARAMETERS<sup>②</sup></b>						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = 5V, V_{DD} = 10V,$ $R_L = 1.35\Omega, R_{GEN} = 3\Omega$		6		ns
Turn-on rise time	$t_r$			13		ns
Turn-off delay time	$t_{d(off)}$			52		ns
Turn-off fall time	$t_f$			16		ns

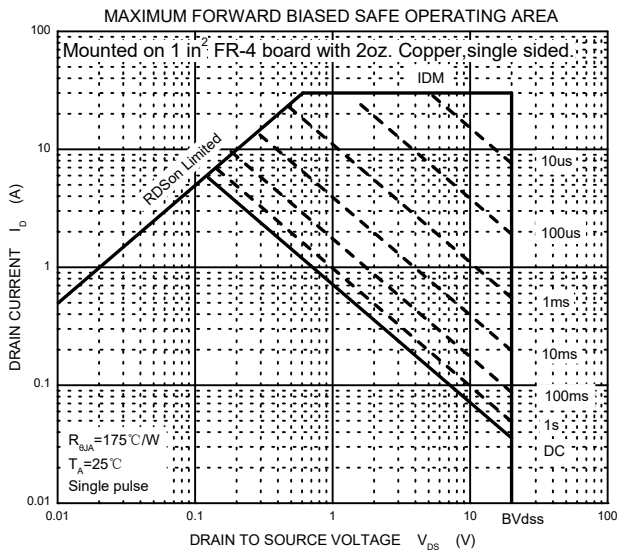
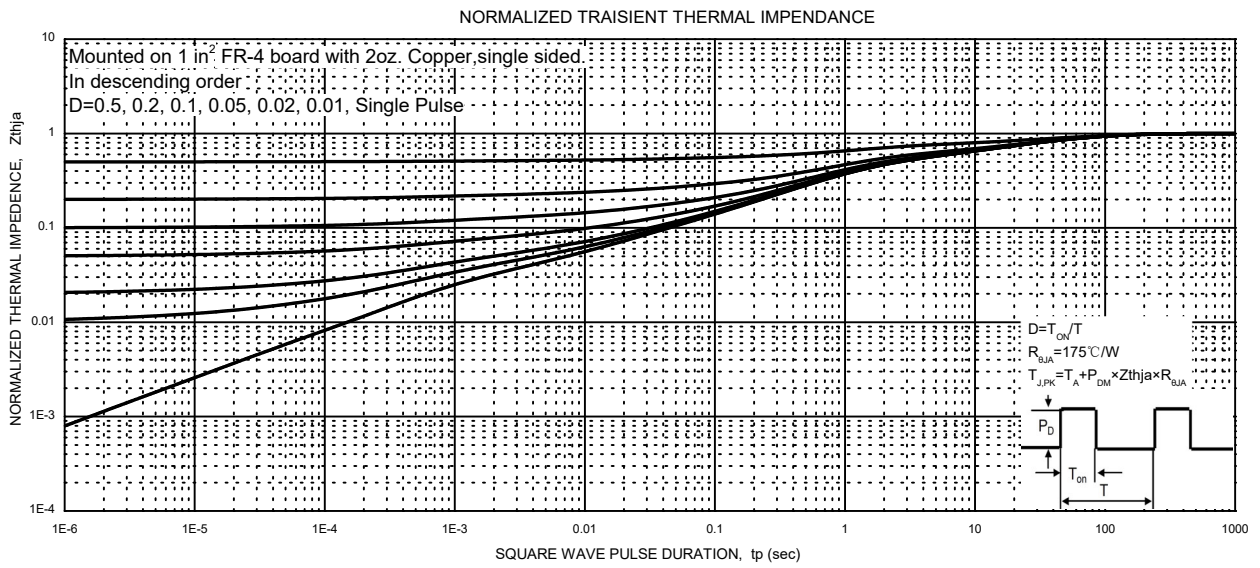
**Notes :**

1. Pulse Test : Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 0.5\%$ .
2. Guaranteed by design, not subject to production testing.
3. The value of  $P_D$  &  $R_{\theta JA}$  is measured with the device one sided activated, mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, single sided, in a still air environment with  $T_a = 25^\circ\text{C}$ .

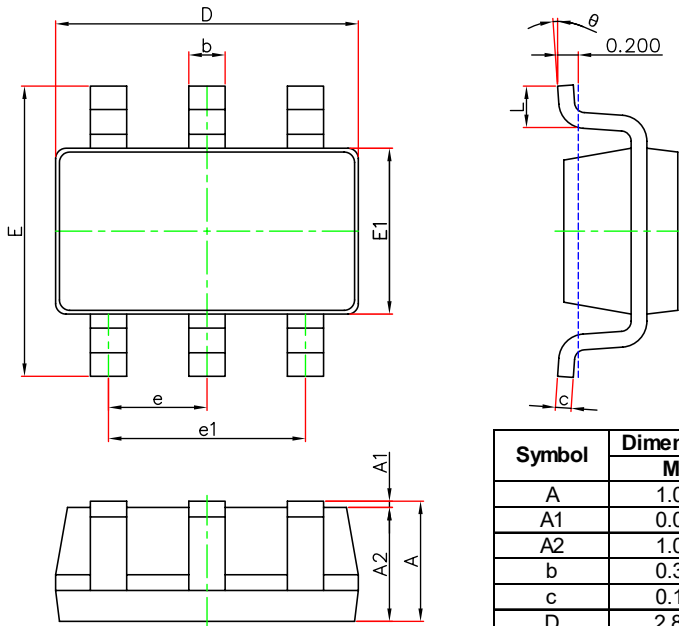
# Typical Characteristics



# Typical Characteristics

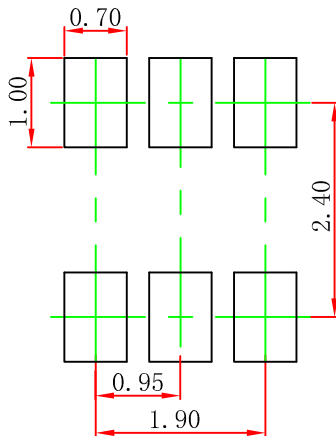


## SOT-23-6L Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
$\theta$	0°	8°	0°	8°

## SOT-23-6L Suggested Pad Layout



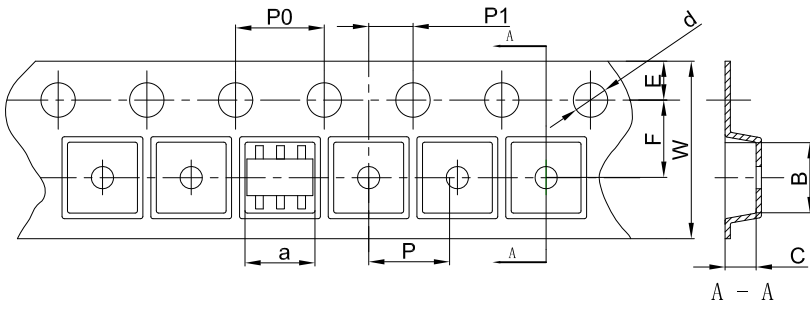
- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance:  $\pm 0.05$  mm.
  3. The pad layout is for reference purposes only.

### NOTICE

JSCJ reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSCJ does not assume any liability arising out of the application or use of any product described herein.

# SOT-23-6L Tape and Reel

## SOT-23-6L Embossed Carrier Tape

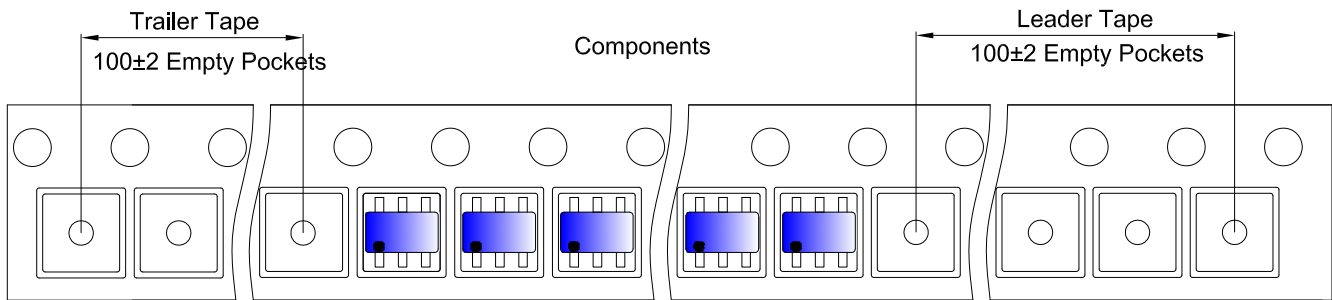


### Packaging Description:

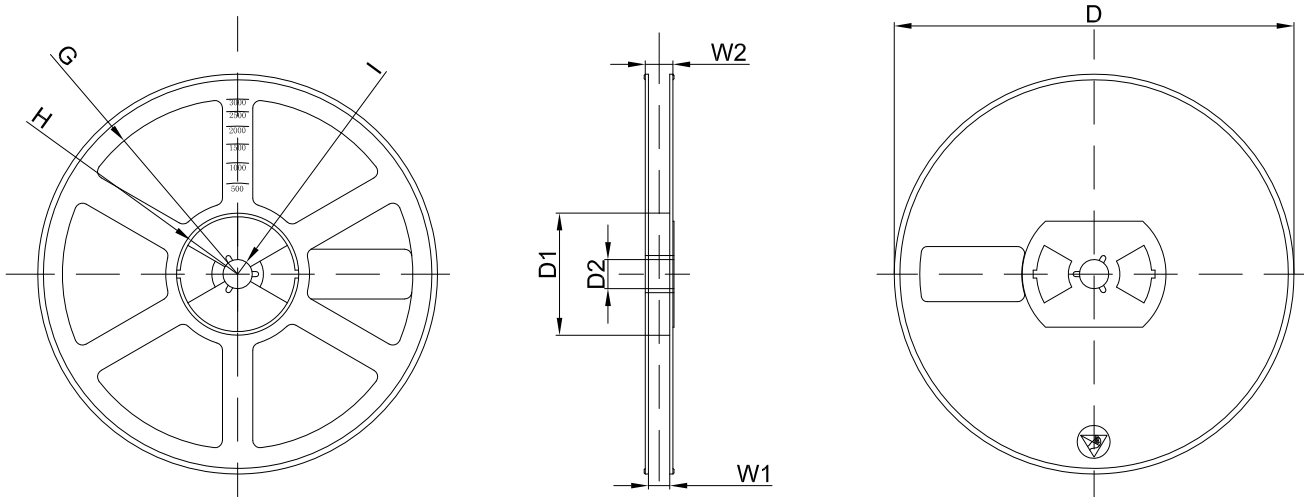
SOT-23-6L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 18.0cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	a	B	C	d	E	F	P0	P	P1	W
SOT-23-6L	3.17	3.23	1.37	Ø1.55	1.75	3.50	4.00	4.00	2.00	8.00

## SOT-23-6L Tape Leader and Trailer



## SOT-23-6L Reel



Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
7" Dia	Ø180.00	60.00	13.00	R78.00	R25.60	R6.50	9.50	13.10

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 inch	30,000 pcs	203×203×195	120,000 pcs	438×438×220	